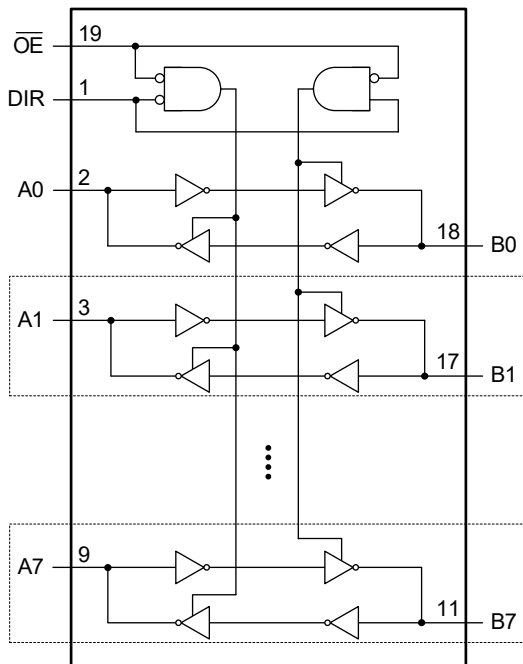


GENERAL DESCRIPTION

The 74HC245 is an 8-bit bus transceiver with 3-state outputs. The supply voltage can accept any voltage from 2.0V to 6.0V. The An and Bn are 8-bit data input-output ports. DIR is the direction control input and \overline{OE} is the output enable input.

When DIR is set high, it allows transmission from An to Bn. When DIR is set low, it allows transmission from Bn to An. \overline{OE} can be used to make the outputs disabled so that the buses are effectively isolated. The clamp diodes of inputs allow the use of current limiting resistors to connect inputs to the voltage exceeding supply voltage.

LOGIC DIAGRAM



FEATURES

- Wide Operating Voltage Range: 2.0V to 6.0V
- CMOS Low Power Consumption
- High Noise Immunity
- Octal Bus Interface with Bidirectional Translation
- 3-State Non-Inverting Outputs
- -40°C to +125°C Operating Temperature Range
- Available in Green SOIC-20 and TSSOP-20 Packages

APPLICATIONS

Network Switch
Telecom Equipment

FUNCTION TABLE

CONTROL INPUT		INPUT/OUTPUT	
\overline{OE}	DIR	An	Bn
L	L	An = Bn	Inputs
L	H	Inputs	Bn = An
H	X	Z	Z

H = High Voltage Level
L = Low Voltage Level
Z = High-Impedance State
X = Don't Care

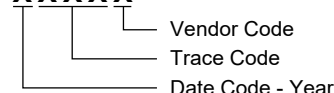
PACKAGE/ORDERING INFORMATION

MODEL	PACKAGE DESCRIPTION	SPECIFIED TEMPERATURE RANGE	ORDERING NUMBER	PACKAGE MARKING	PACKING OPTION
74HC245	SOIC-20	-40°C to +125°C	74HC245XS20G/TR	74HC245XS20 XXXXX	Tape and Reel, 1500
	TSSOP-20	-40°C to +125°C	74HC245XTS20G/TR	0HGXTS20 XXXXX	Tape and Reel, 4000

MARKING INFORMATION

NOTE: XXXXX = Date Code, Trace Code and Vendor Code.

XXXXX



Green (RoHS & HSF): SG Micro Corp defines "Green" to mean Pb-Free (RoHS compatible) and free of halogen substances. If you have additional comments or questions, please contact your SGMICRO representative directly.

ABSOLUTE MAXIMUM RATINGS ⁽¹⁾

Supply Voltage Range, V_{CC}	-0.5V to 7.0V
Input Voltage Range, V_I ⁽²⁾	-0.5V to MIN(7.0V, $V_{CC} + 0.5V$)
Output Voltage Range, V_O ⁽²⁾	-0.5V to MIN(7.0V, $V_{CC} + 0.5V$)
Input Clamp Current, I_{IK} ($V_I < -0.5V$ or $V_I > V_{CC} + 0.5V$)	$\pm 20mA$
Output Clamp Current, I_{OK} ($V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$)	$\pm 20mA$
Continuous Output Current, I_O ($-0.5V < V_O < V_{CC} + 0.5V$)	$\pm 35mA$
Continuous Current through V_{CC} or GND.....	$\pm 70mA$
Junction Temperature ⁽³⁾	+150°C
Storage Temperature Range	-65°C to +150°C
Lead Temperature (Soldering, 10s)	+260°C
ESD Susceptibility	
HBM.....	6000V
CDM	1000V

RECOMMENDED OPERATING CONDITIONS

Supply Voltage Range, V_{CC}	2.0V to 6.0V
Input Voltage Range, V_I	0V to V_{CC}
Output Voltage Range, V_O	0V to V_{CC}
Input Transition Rise or Fall Rate, $\Delta t/\Delta V$	
$V_{CC} = 2.0V$	625ns/V (MAX)
$V_{CC} = 4.5V$	139ns/V (MAX)
$V_{CC} = 5.5V$	83ns/V (MAX)
$V_{CC} = 6.0V$	83ns/V (MAX)
Operating Temperature Range	-40°C to +125°C

OVERSTRESS CAUTION

1. Stresses beyond those listed in Absolute Maximum Ratings may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect reliability. Functional operation of the device at any conditions beyond those indicated in the Recommended Operating Conditions section is not implied.
2. The input and output negative voltage ratings may be exceeded if the input and output clamp current ratings are observed.
3. The performance capability of a high-performance integrated circuit in conjunction with its thermal environment can create junction temperatures which are detrimental to reliability.

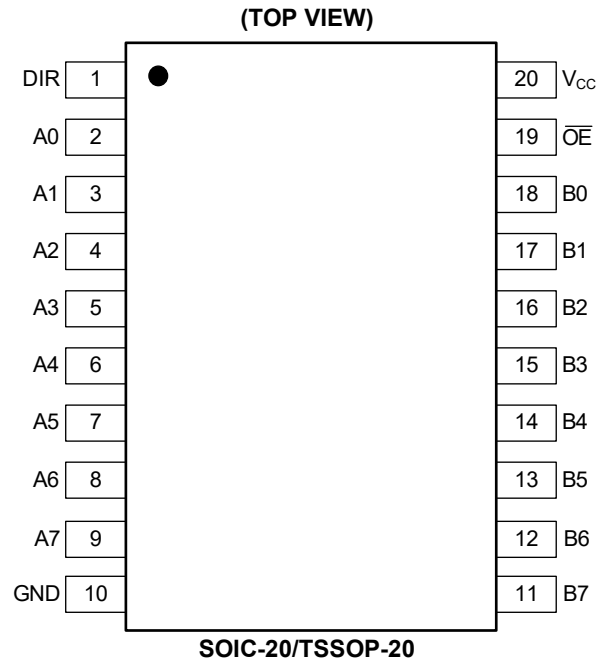
ESD SENSITIVITY CAUTION

This integrated circuit can be damaged if ESD protections are not considered carefully. SGMICRO recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage. ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because even small parametric changes could cause the device not to meet the published specifications.

DISCLAIMER

SG Micro Corp reserves the right to make any change in circuit design, or specifications without prior notice.

PIN CONFIGURATIONS



PIN DESCRIPTION

PIN	NAME	FUNCTION
1	DIR	Direction Control Input.
2, 3, 4, 5, 6, 7, 8, 9	A0, A1, A2, A3, A4, A5, A6, A7	Data Inputs/Outputs.
10	GND	Ground.
18, 17, 16, 15, 14, 13, 12, 11	B0, B1, B2, B3, B4, B5, B6, B7	Data Inputs/Outputs.
19	\overline{OE}	Output Enable Input (Active-Low).
20	V _{CC}	Supply Voltage.

ELECTRICAL CHARACTERISTICS(Full = -40°C to +125°C, all typical values are measured at $V_{CC} = 3.3V$ and $T_A = +25^\circ C$, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN	TYP	MAX	UNITS
High-Level Input Voltage	V_{IH}	$V_{CC} = 2.0V$	Full	1.50			V
		$V_{CC} = 4.5V$	Full	3.15			
		$V_{CC} = 5.5V$	Full	3.85			
		$V_{CC} = 6.0V$	Full	4.20			
Low-Level Input Voltage	V_{IL}	$V_{CC} = 2.0V$	Full			0.50	V
		$V_{CC} = 4.5V$	Full			1.35	
		$V_{CC} = 5.5V$	Full			1.65	
		$V_{CC} = 6.0V$	Full			1.80	
High-Level Output Voltage	V_{OH}	$V_{CC} = 2.0V, I_{OH} = -20\mu A$	Full	1.95	1.998		V
		$V_{CC} = 4.5V, I_{OH} = -20\mu A$	Full	4.45	4.498		
		$V_{CC} = 5.5V, I_{OH} = -20\mu A$	Full	5.45	5.498		
		$V_{CC} = 6.0V, I_{OH} = -20\mu A$	Full	5.95	5.998		
		$V_{CC} = 4.5V, I_{OH} = -6mA$	Full	4.00	4.290		
		$V_{CC} = 5.5V, I_{OH} = -7.8mA$	Full	5.00	5.260		
		$V_{CC} = 6.0V, I_{OH} = -7.8mA$	Full	5.50	5.790		
Low-Level Output Voltage	V_{OL}	$V_{CC} = 2.0V, I_{OL} = 20\mu A$	Full		0.002	0.05	V
		$V_{CC} = 4.5V, I_{OL} = 20\mu A$	Full		0.002	0.05	
		$V_{CC} = 5.5V, I_{OL} = 20\mu A$	Full		0.002	0.05	
		$V_{CC} = 6.0V, I_{OL} = 20\mu A$	Full		0.002	0.05	
		$V_{CC} = 4.5V, I_{OL} = 6mA$	Full		0.18	0.4	
		$V_{CC} = 5.5V, I_{OL} = 7.8mA$	Full		0.22	0.4	
		$V_{CC} = 6.0V, I_{OL} = 7.8mA$	Full		0.20	0.4	
Input Leakage Current	I_I	$V_{CC} = 6.0V, V_I = V_{CC}$ or GND	Full			± 1	μA
Off-State Output Current	I_{OZ}	$V_{CC} = 6.0V, V_I = V_{IH}$ or $V_{IL}, V_O = V_{CC}$ or GND	Full			± 5	μA
Supply Current	I_{CC}	$V_{CC} = 6.0V, V_I = GND$ or $V_{CC}, I_O = 0A$	Full			5	μA
Input Capacitance	C_I	DIR, \overline{OE} inputs	+25°C		4		pF
Input/Output Capacitance	$C_{I/O}$	At input/output data pins, outputs disabled	+25°C		10		pF

DYNAMIC CHARACTERISTICS(See Figure 1 for test circuit. Full = -40°C to +125°C, all typical values are measured at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS	TEMP	MIN ⁽¹⁾	TYP	MAX ⁽¹⁾	UNITS	
Propagation Delay ⁽²⁾	t _{PD}	An to Bn or Bn to An, see Figure 2	V _{CC} = 2.0V	Full	7	28	100	ns
			V _{CC} = 4.5V	Full	4	10	25	
			V _{CC} = 5.5V	Full	4	9	23	
			V _{CC} = 6.0V	Full	3	9	23	
Enable Time ⁽²⁾	t _{EN}	OE to An or Bn, see Figure 3	V _{CC} = 2.0V	Full	11	30	100	ns
			V _{CC} = 4.5V	Full	5	11	30	
			V _{CC} = 5.5V	Full	4	9	25	
			V _{CC} = 6.0V	Full	4	9	25	
Disable Time ⁽²⁾	t _{DIS}	OE to An or Bn, see Figure 3	V _{CC} = 2.0V	Full	6	14	40	ns
			V _{CC} = 4.5V	Full	4	9	30	
			V _{CC} = 5.5V	Full	4	8	25	
			V _{CC} = 6.0V	Full	3	8	25	
Transition Time ⁽²⁾	t _T	See Figure 2	V _{CC} = 2.0V	Full	4	17	80	ns
			V _{CC} = 4.5V	Full	1	5	18	
			V _{CC} = 5.5V	Full	1	4	15	
			V _{CC} = 6.0V	Full	0.5	4	15	
Power Dissipation Capacitance ⁽³⁾	C _{PD}	Per input, V _{CC} = 3.3V, V _I = GND to V _{CC}	+25°C		10		pF	

NOTES:

- Specified by design and characterization, not production tested.
- t_{PD} is the same as t_{PLH} and t_{PHL}. t_{DIS} is the same as t_{PLZ} and t_{PHZ}. t_{EN} is the same as t_{PZL} and t_{PZH}. t_T is the same as t_{THL} and t_{TLH}.
- C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma(C_L \times V_{CC}^2 \times f_o)$$

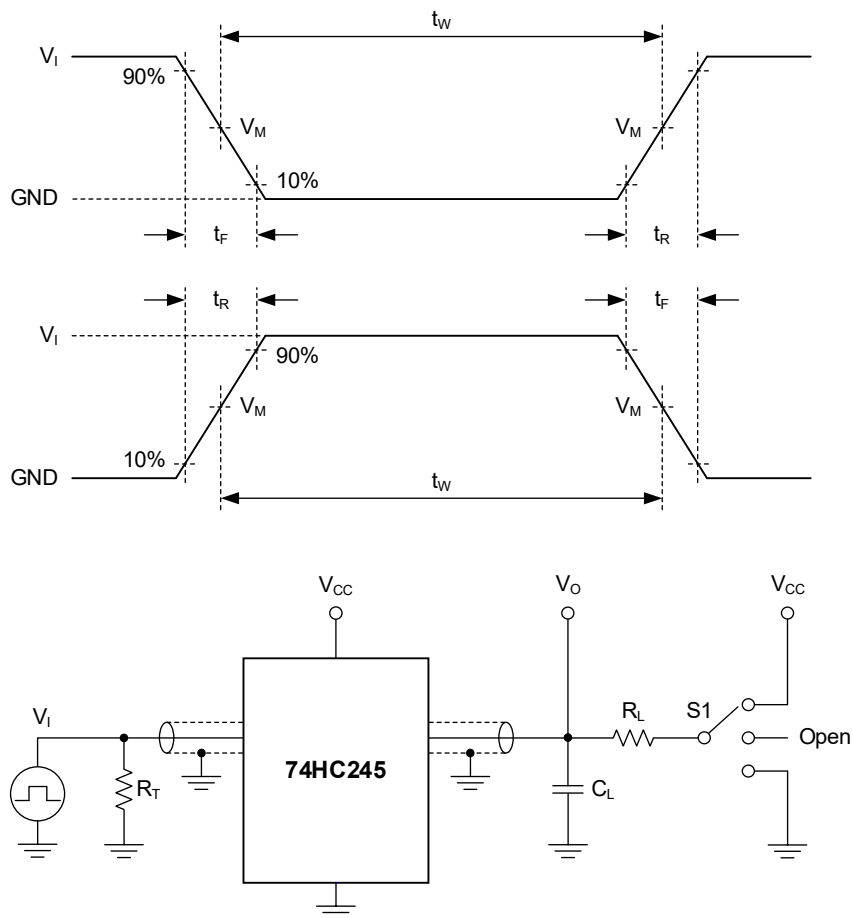
where:

f_i = Input frequency in MHz.f_o = Output frequency in MHz.C_L = Output load capacitance in pF.V_{CC} = Supply voltage in Volts.

N = Number of inputs switching.

Σ(C_L × V_{CC}² × f_o) = Sum of outputs.

TEST CIRCUIT



Test conditions are given in Table 1.

Definitions for test circuit:

R_L : Load resistance.

C_L : Load capacitance (includes jig and probe).

R_T : Termination resistance (equals to output impedance Z_O of the pulse generator).

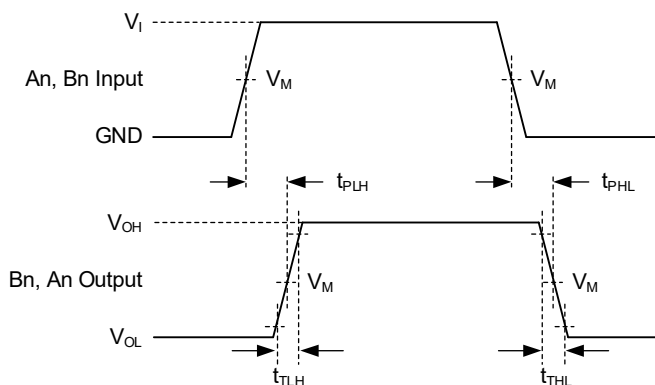
S1: Test selection switch.

Figure 1. Test Circuit for Measuring Switching Times

Table 1. Test Conditions

SUPPLY VOLTAGE	INPUT		LOAD		S1 POSITION		
	V_I	t_R, t_F	C_L	R_L	t_{PHL}, t_{PLH}	t_{PZH}, t_{PHZ}	t_{PZL}, t_{PLZ}
V_{CC} 2.0V to 6.0V	V_{CC}	≤ 6 ns	50pF	1k Ω	Open	GND	V_{CC}

WAVEFORMS

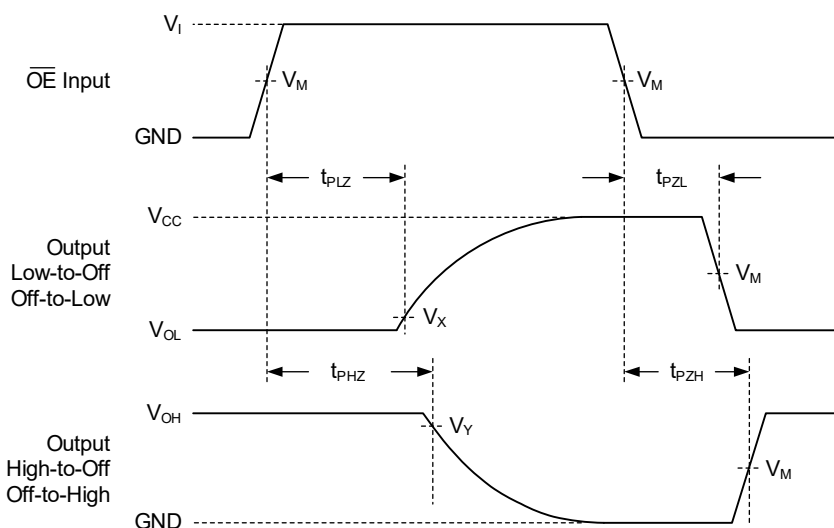


Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 2. Input (An, Bn) to Output (Bn, An) Propagation Delays



Test conditions are given in Table 1.

Measurement points are given in Table 2.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Figure 3. Enable and Disable Times

Table 2. Measurement Points

SUPPLY VOLTAGE	INPUT		OUTPUT		
V_{CC}	V_I	$V_M^{(1)}$	V_M	V_X	V_Y
2.0V to 6.0V	V_{CC}	$0.5 \times V_{CC}$	$0.5 \times V_{CC}$	$0.1 \times V_{CC}$	$0.9 \times V_{CC}$

NOTE:

1. The measurement points should be V_{IH} or V_{IL} when the input rising or falling time exceeds 6ns.

REVISION HISTORY

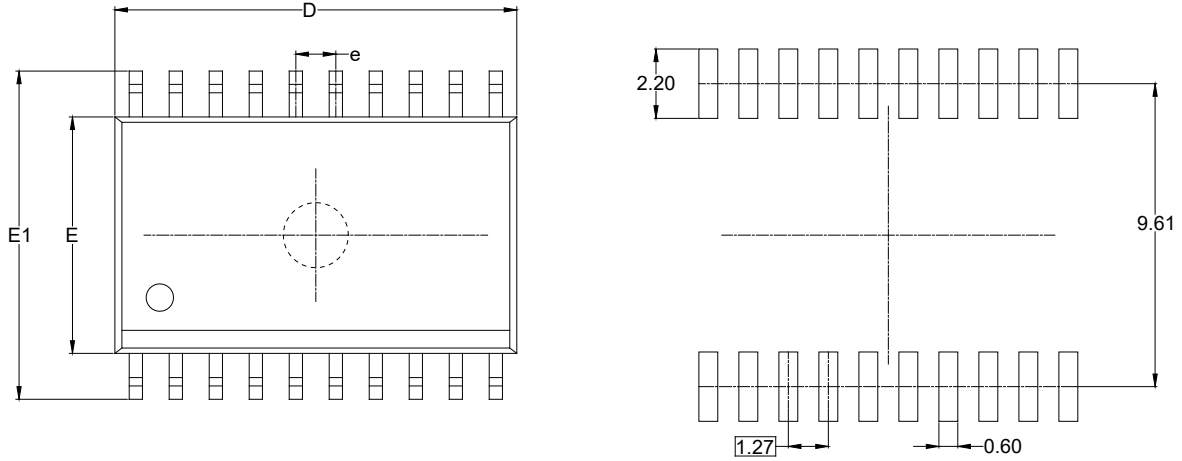
NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

JANUARY 2026 – REV.A to REV.A.1	Page
Updated Supply Voltage Range.....	All

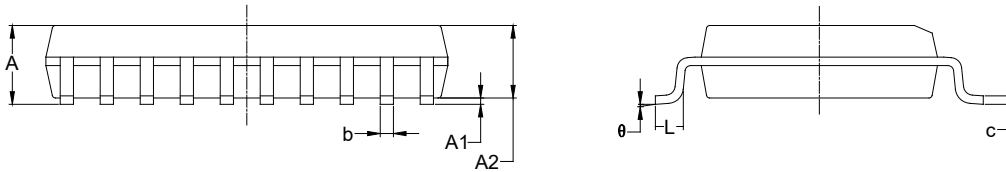
Changes from Original to REV.A (SEPTEMBER 2023)	Page
Changed from product preview to production data.....	All

PACKAGE OUTLINE DIMENSIONS

SOIC-20



RECOMMENDED LAND PATTERN (Unit: mm)



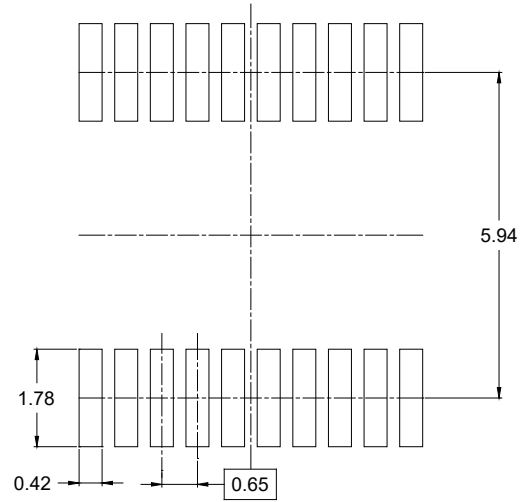
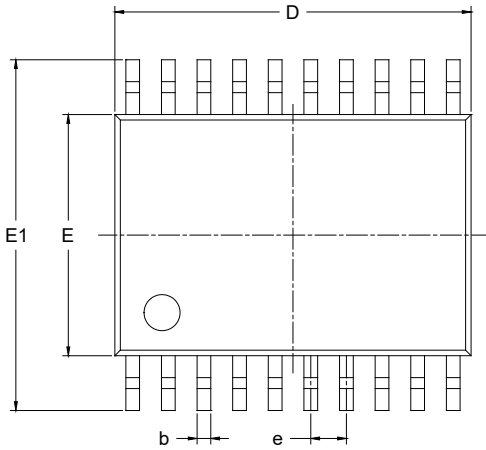
Symbol	Dimensions In Millimeters		Dimensions In Inches	
	MIN	MAX	MIN	MAX
A	2.350	2.650	0.093	0.104
A1	0.100	0.300	0.004	0.012
A2	2.100	2.500	0.083	0.098
b	0.330	0.510	0.013	0.020
c	0.204	0.330	0.008	0.013
D	12.520	13.000	0.493	0.512
E	7.400	7.600	0.291	0.299
E1	10.210	10.610	0.402	0.418
e	1.27 BSC		0.050 BSC	
L	0.400	1.270	0.016	0.050
θ	0°	8°	0°	8°

NOTES:

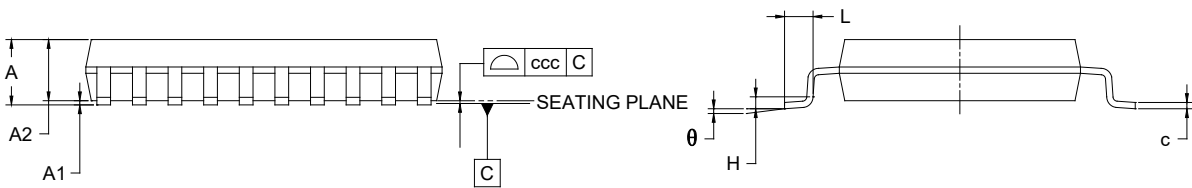
1. Body dimensions do not include mode flash or protrusion.
2. This drawing is subject to change without notice.

PACKAGE OUTLINE DIMENSIONS

TSSOP-20



RECOMMENDED LAND PATTERN (Unit: mm)



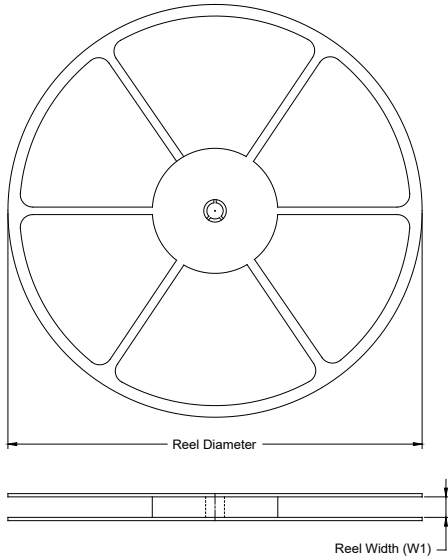
Symbol	Dimensions In Millimeters		
	MIN	NOM	MAX
A	-	-	1.200
A1	0.050	-	0.150
A2	0.800	-	1.050
b	0.190	-	0.300
c	0.090	-	0.200
D	6.400	-	6.600
E	4.300	-	4.500
E1	6.200	-	6.600
e	0.650 BSC		
L	0.450	-	0.750
H	0.250 TYP		
θ	0°	-	8°
ccc	0.100		

NOTES:

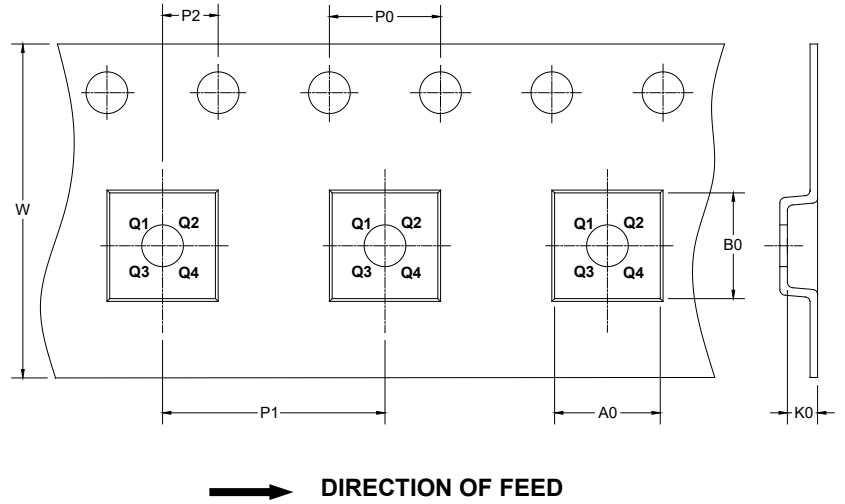
1. Body dimensions do not include mode flash or protrusion.
2. This drawing is subject to change without notice.
3. Reference JEDEC MO-153.

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

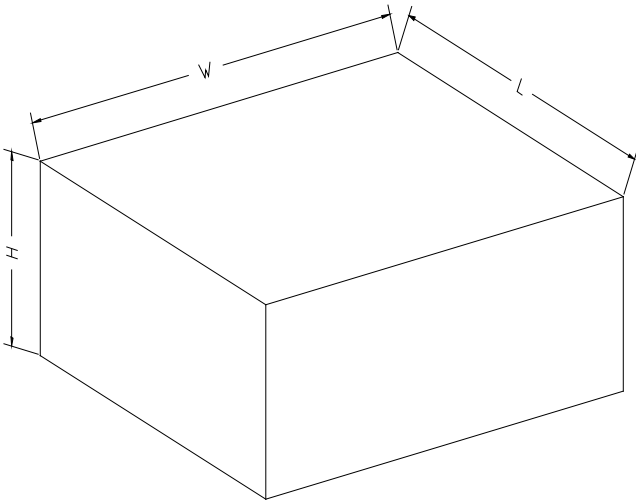
KEY PARAMETER LIST OF TAPE AND REEL

Package Type	Reel Diameter	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	P1 (mm)	P2 (mm)	W (mm)	Pin1 Quadrant
SOIC-20	13"	24.4	10.90	13.30	3.00	4.0	12.0	2.0	24.0	Q1
TSSOP-20	13"	16.4	6.80	6.90	1.50	4.0	8.0	2.0	16.0	Q1

DD0001

PACKAGE INFORMATION

CARTON BOX DIMENSIONS



NOTE: The picture is only for reference. Please make the object as the standard.

KEY PARAMETER LIST OF CARTON BOX

Reel Type	Length (mm)	Width (mm)	Height (mm)	Pizza/Carton
13"	386	280	370	5

DD0002